

# 1MBH20D-060

Molded IGBT

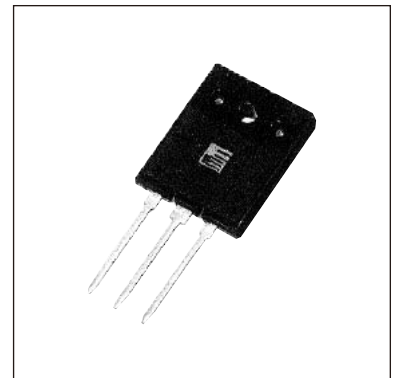
## 600V / 20A Molded Package

### ■ Features

- Small molded package
- Low power loss
- Soft switching with low switching surge and noise
- High reliability, high ruggedness (RBSOA, SCSOA etc.)
- Comprehensive line-up

### ■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply



### ■ Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings (Tc=25°C)

Items	Symbols	Ratings	Units
Collector-Emitter Voltage	V <sub>CEs</sub>	600	V
Gate-Emitter Voltage	V <sub>GEs</sub>	±20	V
Collector Current	DC	TC=25°C	I <sub>C25</sub> 45 A
		TC=110°C	I <sub>C110</sub> 20 A
		TC=25°C	I <sub>cp</sub> 152 A
IGBT Max. Power Dissipation	P <sub>c</sub>	170	W
FWD Max. Power Dissipation	P <sub>c</sub>	95	W
Operating Temperature	T <sub>j</sub>	+150	°C
Storage Temperature	T <sub>stg</sub>	-40 to +150	°C
Mounting Screw Torque	—	70	N·cm

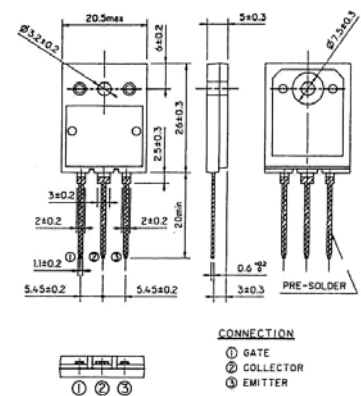
#### ● Electrical Characteristics (at Tc=25°C unless otherwise specified)

Items	Symbols	Characteristics			Conditions	Units		
		min.	typ.	max.				
Zero gate voltage Collector Current	I <sub>CEs</sub>	—	—	1.0	V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V	mA		
Gate-Emitter leakage Current	I <sub>GES</sub>	—	—	20	V <sub>CE</sub> = 0V, V <sub>GE</sub> = ±20V	μA		
Gate-Emitter Threshold Voltage	V <sub>GE(th)</sub>	5.5	—	8.5	V <sub>CE</sub> = 20V, I <sub>c</sub> = 20mA	V		
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	—	—	3.0	V <sub>GE</sub> = 15V, I <sub>c</sub> = 20A	V		
Input capacitance	C <sub>ies</sub>	—	1300	—	V <sub>GE</sub> = 0V V <sub>CE</sub> = 10V f = 1MHz	pF		
Output capacitance	C <sub>oes</sub>	—	300	—				
Reverse transfer capacitance	C <sub>res</sub>	—	70	—				
Switching Time	Turn-on time	t <sub>on</sub>	—	—	V <sub>CC</sub> = 300V I <sub>c</sub> = 20A V <sub>GE</sub> = ±15V R <sub>G</sub> = 120Ω (Half Bridge)	μs		
		t <sub>r</sub>	—	—				
	Turn-off time	t <sub>off</sub>	—	—			V <sub>CC</sub> = 300V I <sub>c</sub> = 20A V <sub>GE</sub> = +15V R <sub>G</sub> = 12Ω (Half Bridge)	
		t <sub>f</sub>	—	—				
	Turn-on time	t <sub>on</sub>	—	0.16				—
		t <sub>r</sub>	—	0.11				—
Turn-off time	t <sub>off</sub>	—	0.30	—				
	t <sub>f</sub>	—	—	0.35				
FWD forward voltage drop	V <sub>F</sub>	—	—	3.0	I <sub>F</sub> = 20A	V		
Reverse recovery time	t <sub>rr</sub>	—	—	0.3	I <sub>F</sub> = 20A, V <sub>GE</sub> = -10V V <sub>R</sub> = 200V di/dt = 100A/μs	μs		

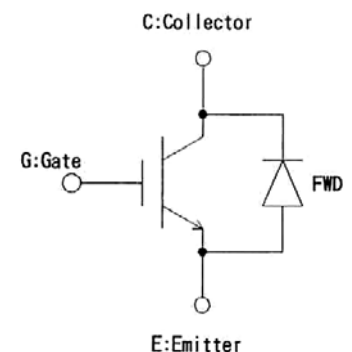
#### ● Thermal resistance Characteristics

Items	Symbols	Characteristics			Conditions	Units
		min.	typ.	max.		
Thermal resistance	R <sub>th(j-c)</sub>	—	—	0.73	IGBT	°C/W
	R <sub>th(j-c)</sub>	—	—	1.31	FWD	

### ■ Outline drawings, mm

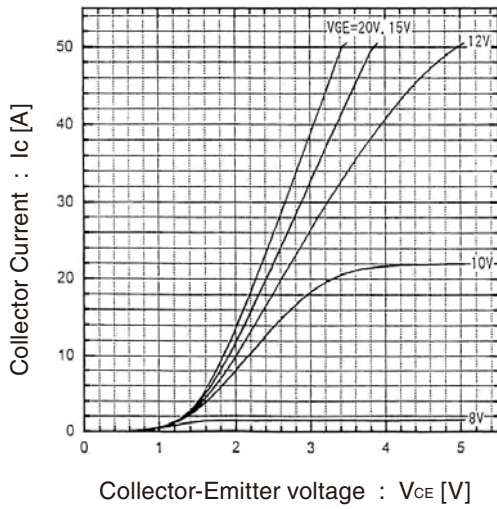


### ■ Equivalent circuit

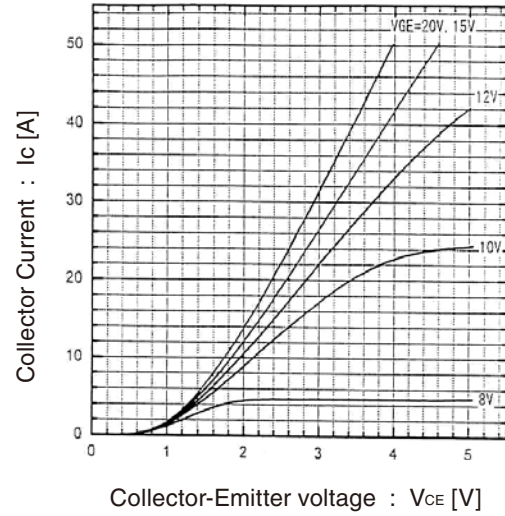


■ Characteristics

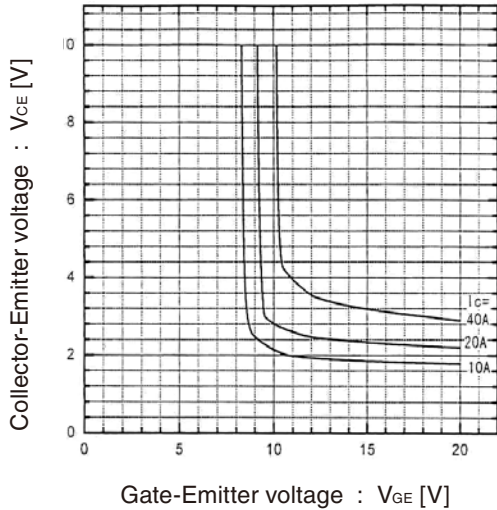
Collector current vs. Collector-Emmitter voltage  
 $T_j = 25^\circ\text{C}$



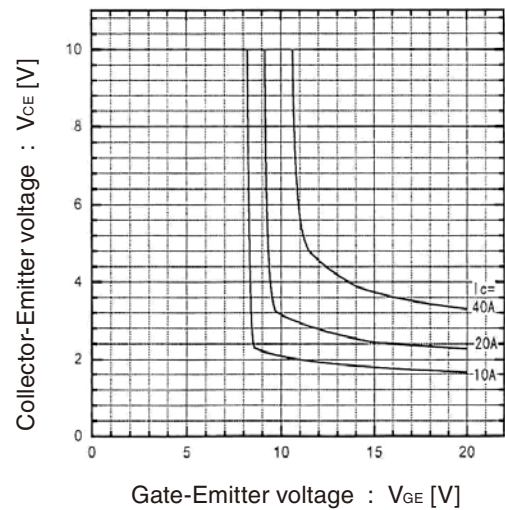
Collector current vs. Collector-Emmitter voltage  
 $T_j = 125^\circ\text{C}$



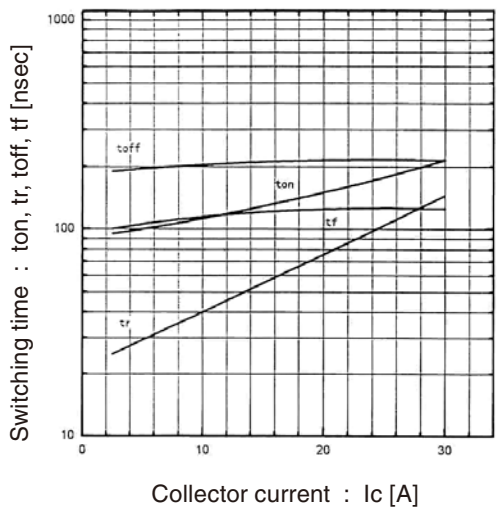
Collector-Emmitter voltage vs. Gate-Emmitter Voltage  
 $T_j = 25^\circ\text{C}$



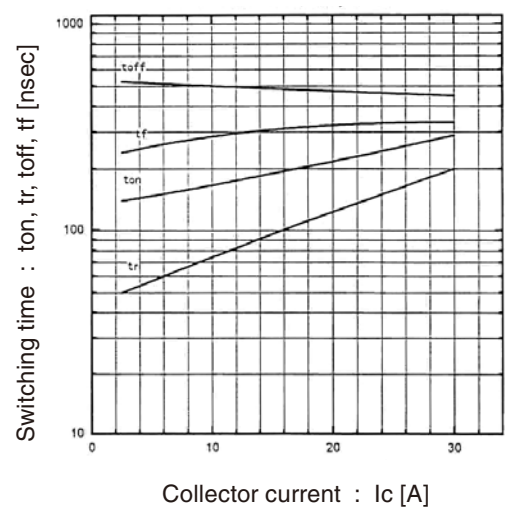
Collector-Emmitter voltage vs. Gate-Emmitter Voltage  
 $T_j = 125^\circ\text{C}$



Switching time vs. Collector current  
 $V_{cc}=300\text{V}, R_G=12\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$

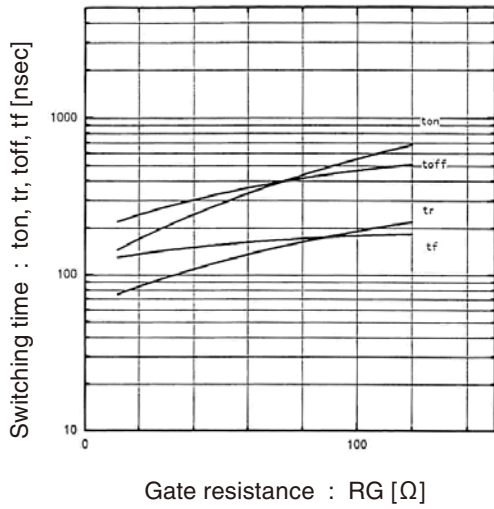


Switching time vs. Collector current  
 $V_{cc}=300\text{V}, R_G=12\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$

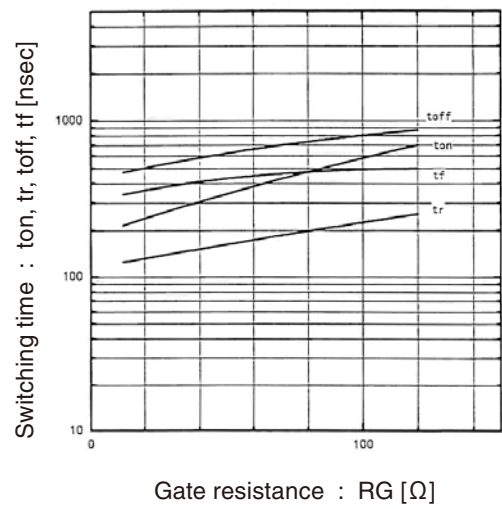


■ Characteristics

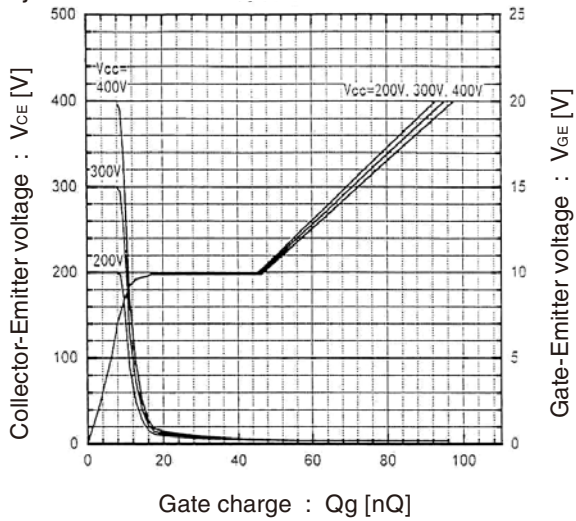
Switching time vs. RG  
 $V_{CC}=300V, I_C=20A, V_{GE}=\pm 15V, T_j=25^\circ C$



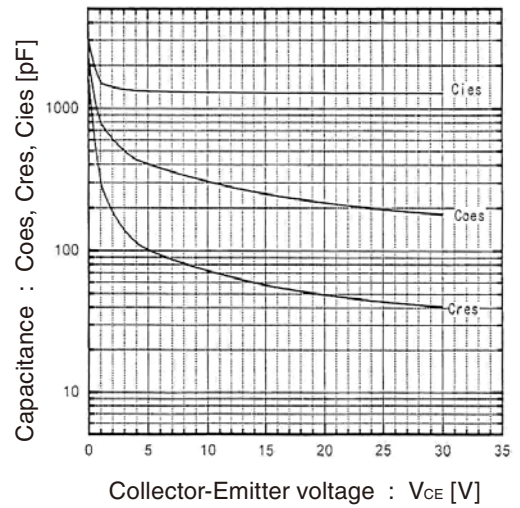
Switching time vs. RG  
 $V_{CC}=300V, I_C=20A, V_{GE}=\pm 15V, T_j=125^\circ C$



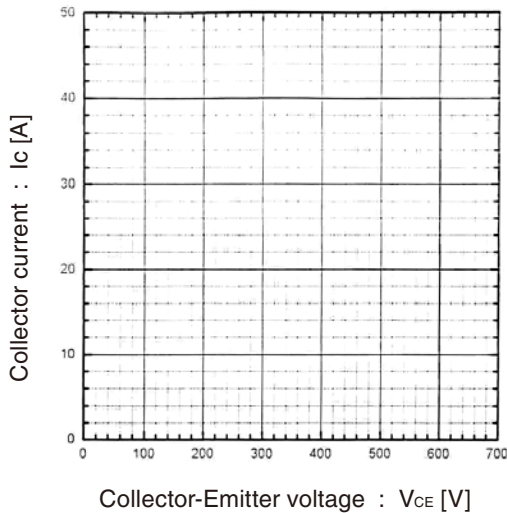
Dynamic input characteristics  
 $T_j=25^\circ C$



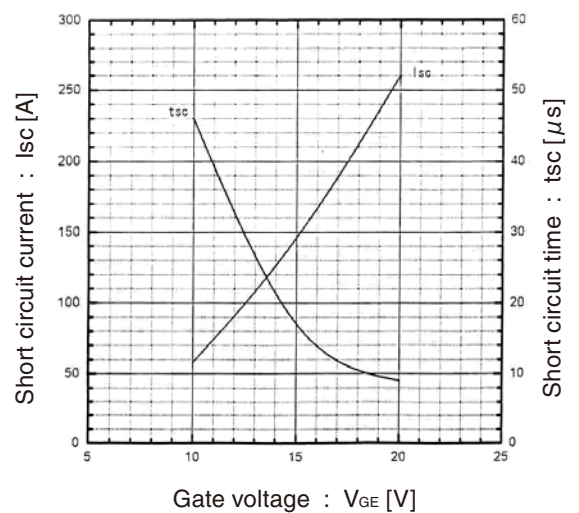
Capacitance vs. Collector-Emitter voltage  
 $T_j=25^\circ C$



Reverse Biased Safe Operating Area  
 $+V_{GE}=15V, -V_{GE}\le 15V, T_j=125^\circ C, R_G\ge 12\Omega$

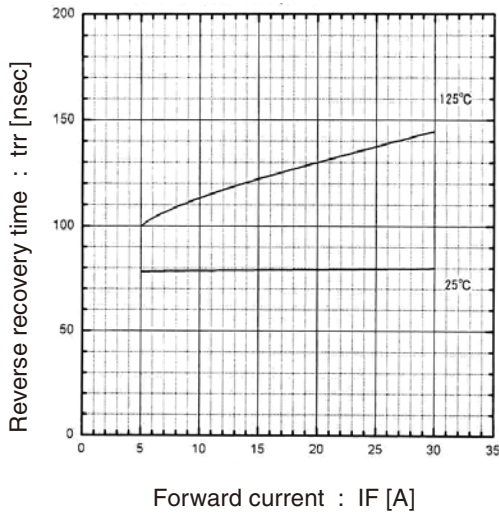


Typical short circuit capability  
 $V_{CC}=400V, R_G=12\Omega, T_j=125^\circ C$

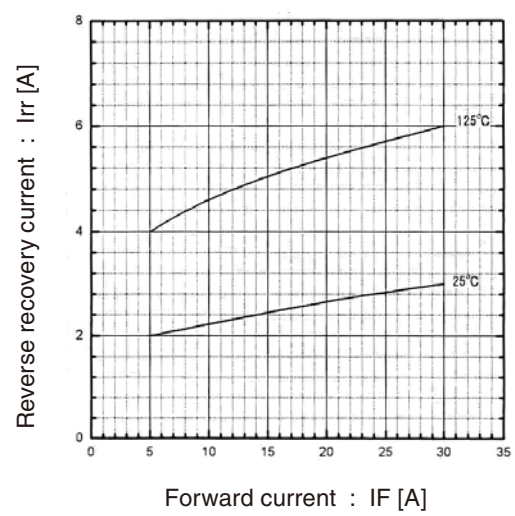


■ Characteristics

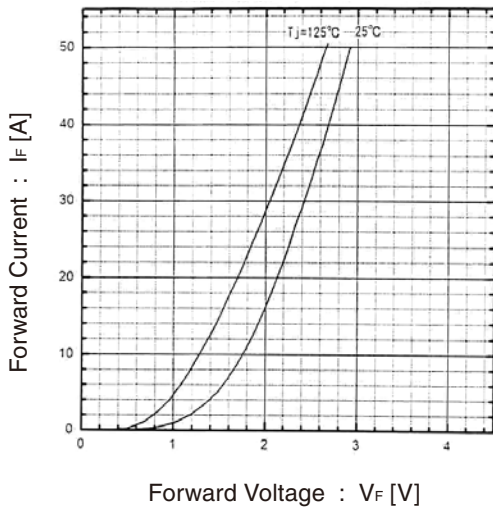
Reverse recovery time vs. Forward current  
 $V_R=200V, -di/dt=100A/\mu sec$



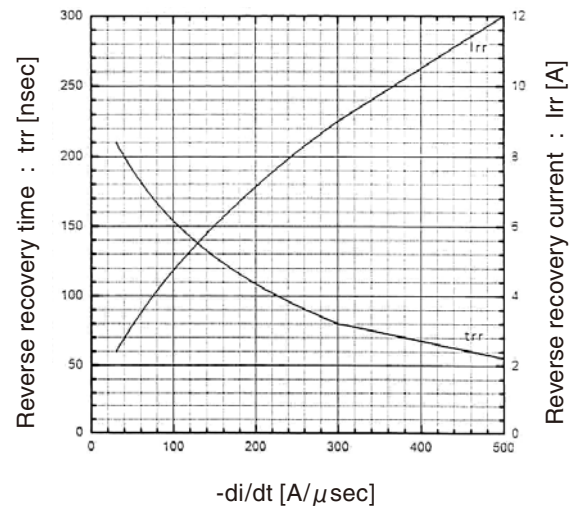
Reverse recovery current vs. Forward current  
 $V_R=200V, -di/dt=100A/\mu sec$



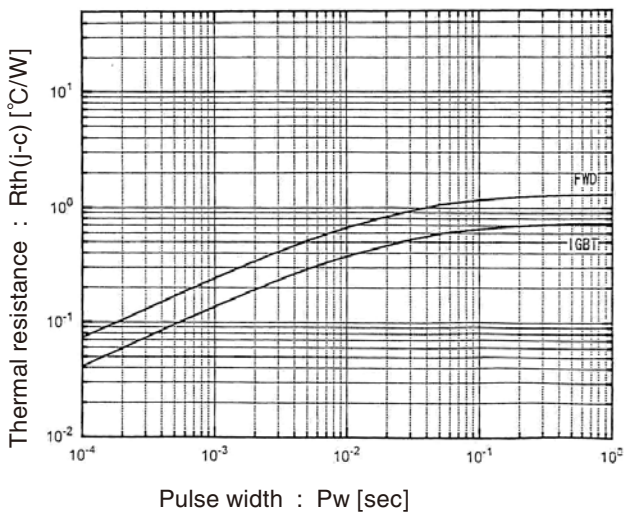
Forward voltage vs. Forward current



Reverse recovery characteristics vs. -di/dt  
 $I_F=20A, T_j=125^\circ C$



Transient thermal resistance



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  - Audiovisual equipment
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